

**MOSFETs Silicon 40V N-Channel MOS**
**■ Applications**

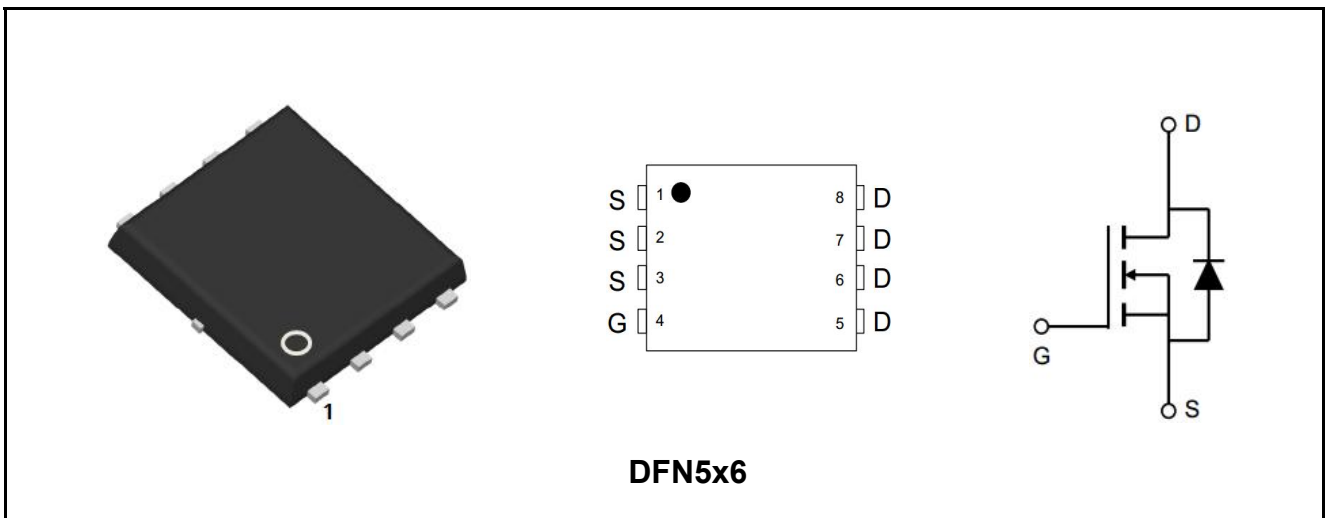
- Load Switch
- Power management in portable/desktop PCs
- DC/DC Converters

**■ Features**

- High Current Capability
- Reliable and Rugged
- Low On-Resistance
- Capable of 4.5 V Gate Drive
- RoHS and Halogen-Free Compliant
- 100% UIS and RG Tested

**■ Product Summary**

$V_{DS}$	40	V
$I_D$	65	A
$R_{DS(ON), Typ@10V}$	5.1	m $\Omega$
$R_{DS(ON), Typ@4.5V}$	6.8	m $\Omega$
$Q_g$	15	nC



Marking	Package	Packaging	Min. package quantity
MDG006R040SL	DFN5x6	Tape & Reel	5000



**■ Absolute Maximum Ratings (Tc=25°C unless otherwise noted)**

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	$V_{DS}$	40	V
Gate-Source Voltage	$V_{GS}$	±20	V
Continuous Drain Current Tc=25°C (Note 1)	$I_D$	65	A
Continuous Drain Current Tc=100°C (Note 1)		45	A
Drain Current-Pulsed (Note 1)	$I_{DM}$	170	A
Total Dissipation	$P_D$	50	W
Junction Temperature	$T_j$	150	°C
Storage Temperature	$T_{stg}$	-55-150	°C
Single Pulse Avalanche Energy (Note 2)	$E_{AS}$	60	mJ

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

**■ Thermal Characteristics**

Parameter	Symbol	Max	Unit
Maximum Junction-to-Case	$R_{\theta JC}$	2.5	°C/W
Maximum Junction-to-Ambient (Note 3)	$R_{\theta JA}$	50	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD}=50V$ ,  $T_{ch}=25^\circ C$ (initial),  $L=0.5mH$ ,  $R_g=25\Omega$ .

Note 3: The value of  $R_{\theta JA}$  is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ C$ . The value in any given application depends on the user's specific board design.

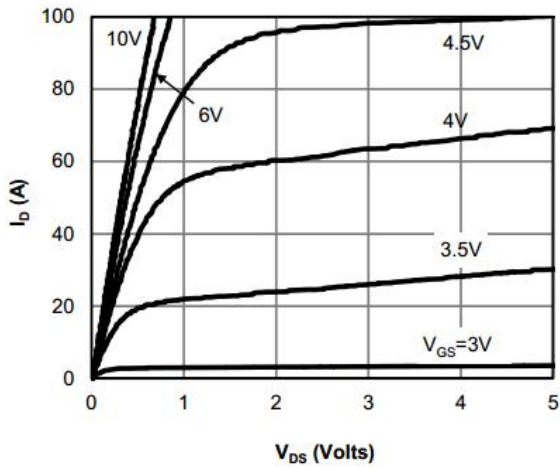
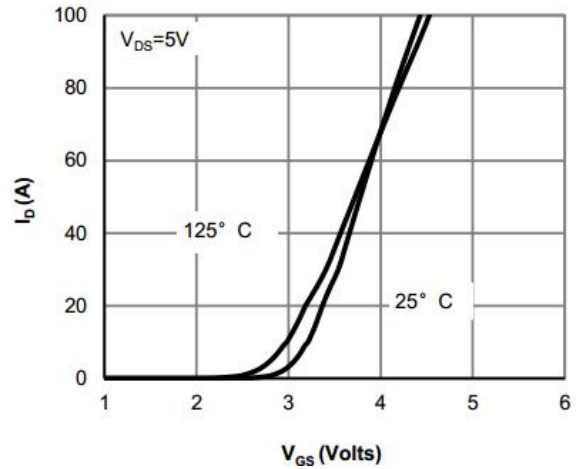
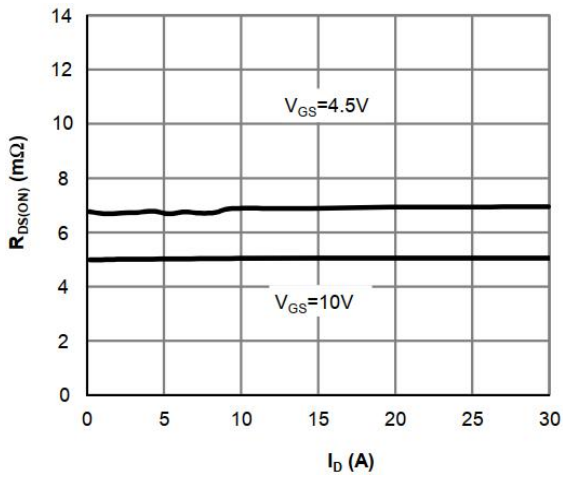
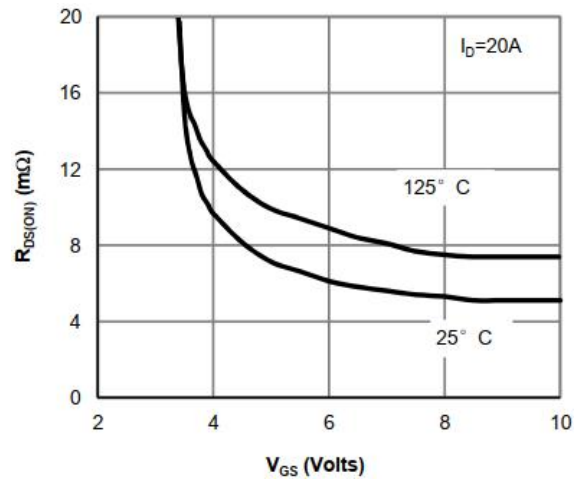
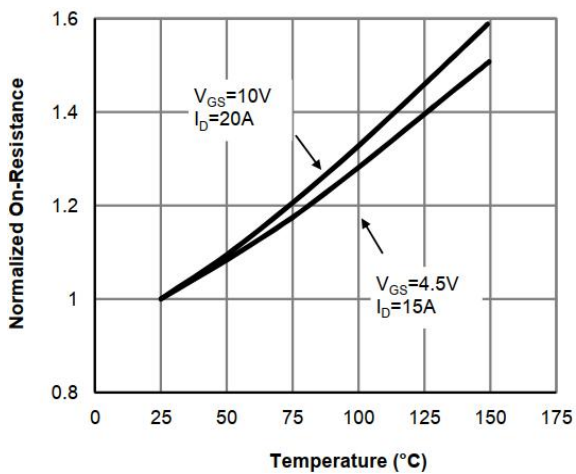
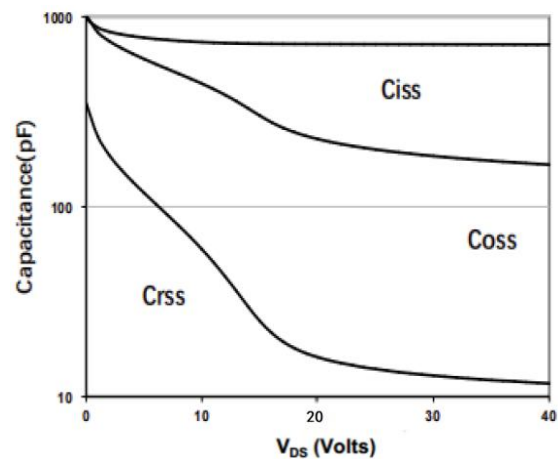
Note: This transistor is sensitive to electrostatic discharge and should be handled with care.

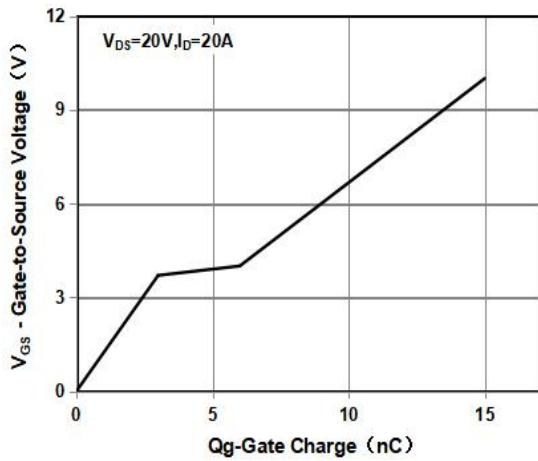


**■ Electrical Characteristics (Tc=25°C unless otherwise noted)**

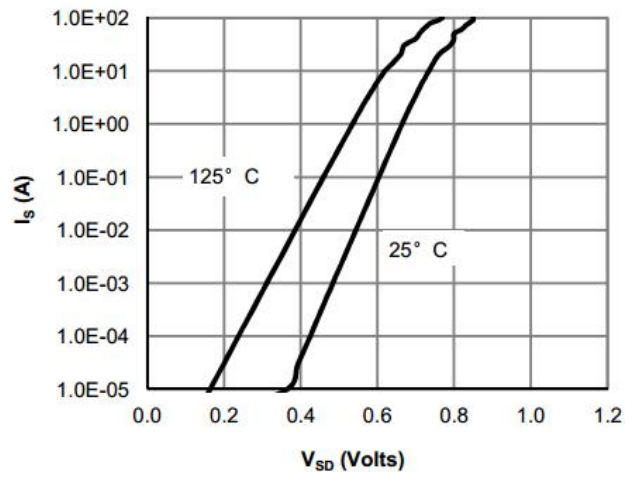
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>Static Parameters</b>						
Drain-Source Breakdown Voltage	$BV_{DSS}$	$V_{GS}=0V, I_D=250\mu A$	40	-	-	V
Drain-Source Leakage Current	$I_{DSS}$	$V_{DS}=40V, V_{GS}=0V$	-	-	1	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	1.0	1.5	2.0	V
Drain-Source On Resistance	$R_{DS(ON)}$	$V_{GS}=4.5V, I_D=15A$	-	6.8	8.5	m $\Omega$
		$T_j=125^\circ C$	-	9.5	-	
		$V_{GS}=10V, I_D=20A$	-	5.1	6	
		$T_j=125^\circ C$	-	7.5	-	
<b>Dynamic Characteristics</b>						
Input Capacitance	$C_{iss}$	$V_{DS}=20V, V_{GS}=0V,$ $f=1.0MHz$	-	720	-	pF
Output Capacitance	$C_{oss}$		-	230	-	pF
Reverse Transfer Capacitance	$C_{rss}$		-	15	-	pF
Gate Resistance	$R_g$	$V_{DS}=0V, V_{GS}=0V,$ $f=1.0MHz$	-	1.1	-	$\Omega$
<b>Switching Paramters</b>						
Turn-On Delay Time	$t_{d(on)}$	$V_{DS}=20V, I_D=20A,$ $V_{GS}=10V, R_G=3\Omega$	-	3.5	-	ns
Turn-On Rise Time	$t_r$		-	30	-	ns
Turn-Off Delay Time	$t_{d(off)}$		-	12	-	ns
Turn-Off Rise Time	$t_f$		-	8	-	ns
Total Gate Charge	$Q_g$	$V_{DS}=20V, I_D=20A,$ $V_{GS}=10V$	-	15	-	nC
	$Q_g(4.5V)$		-	7	-	nC
Gate-Source Charge	$Q_{gs}$		-	3	-	nC
Gate-Drain Charge	$Q_{gd}$		-	3	-	nC
<b>Source-Drain Characteristics</b>						
Diode Forward Voltage	$V_{sd}$	$V_{GS}=0V, I_S=10A$	-	0.75	1.2	V
Reverse Recovery Time	$t_{rr}$	$V_{GS}=0V, I_F=20A,$ $di/dt=100A/\mu s$	-	15.5	-	ns
Reverse Recovery Charge	$Q_{rr}$		-	2.5	-	nC



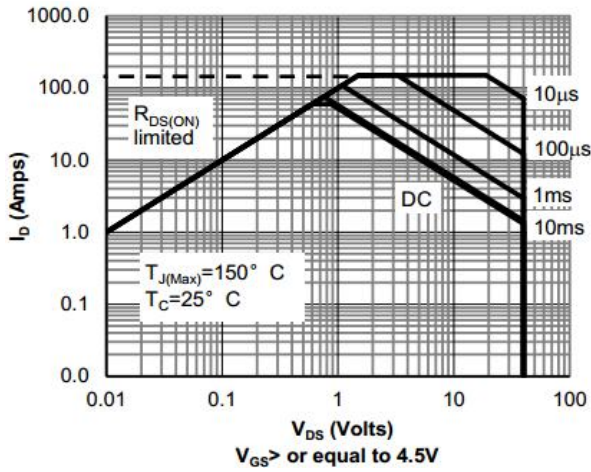
**■ Characteristics Curves**

**Output Characteristics**

**Transfer Characteristics**

**On Resistance Vs Drain Current**

**On Resistance Vs Gate Source Voltage**

**Rdson-JunctionTemperature**

**Capacitance**

Gate Charge Waveform



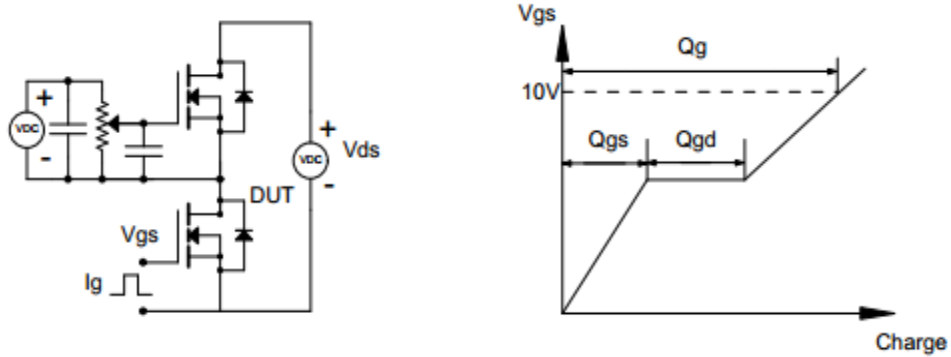
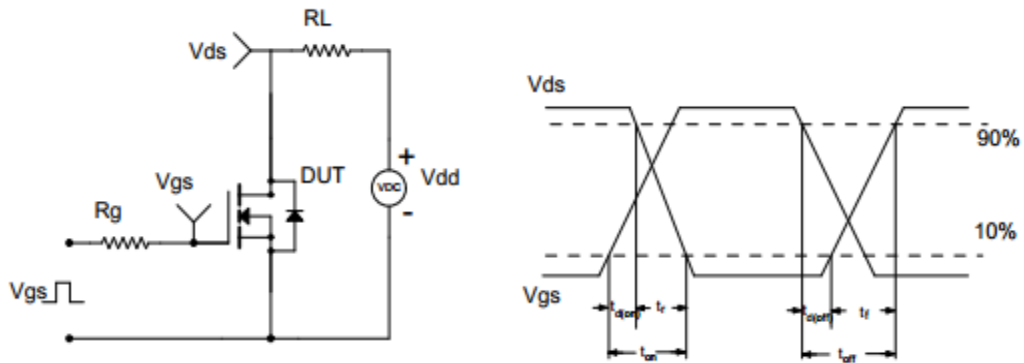
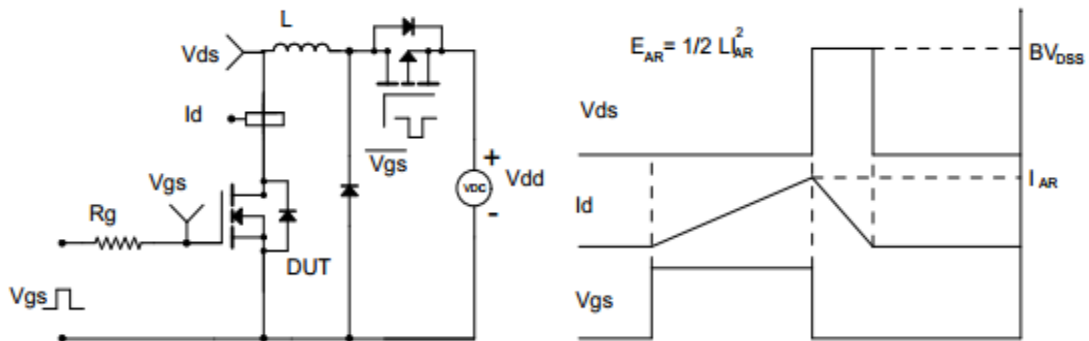
Source-Drain Diode Forward Voltage



Maximum Safe Operating Area

Note : The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



**■ Test Circuit & Waveform**
**Gate Charge Test Circuit & Waveform**

**Resistive Switching Test Circuit & Waveform**

**Unclamped Inductive Switching (UIS) Test Circuit & Waveform**


**DFN5x6 Package Dimensions**

Unit: mm

Symbol	Min	Nom	Max	Symbol	Min	Nom	Max
A	0.90		1.10	k	1.15		1.35
A3	0.15		0.30	b	0.20		0.40
D	5.05		5.25	e	1.15		1.35
D1	4		4.2	L	0.50		0.65
D2	4.75		5.05	L1	0.43		0.55
E	5.85		6.15	H	0.55		0.68
E1	3.35		3.55	$\theta$	8°		12°
E2	5.55		5.85				

